



Passive Nano- and Micro-Textured Dust-Mitigation Surfaces in Space-Grade Materials Made with a Highly Scalable Fabrication Process

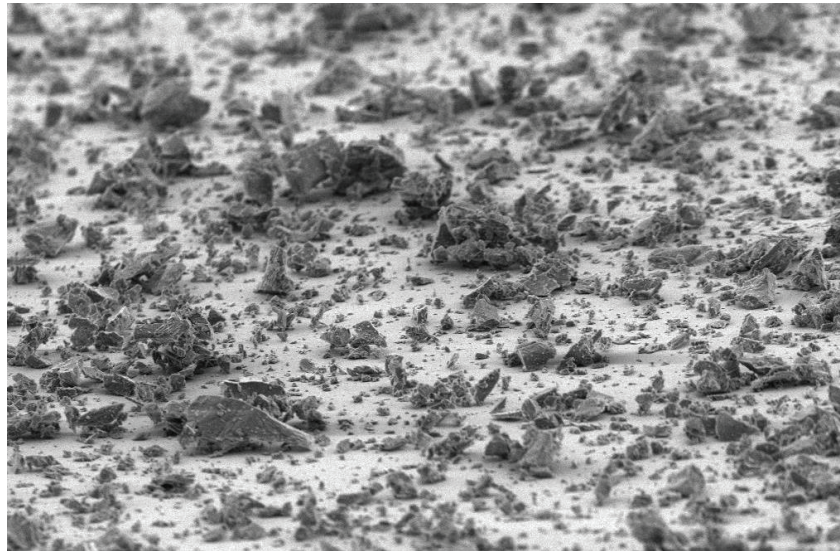
LSIC Lunch Meeting January 20, 2022

Smart Material Solutions, Inc.:

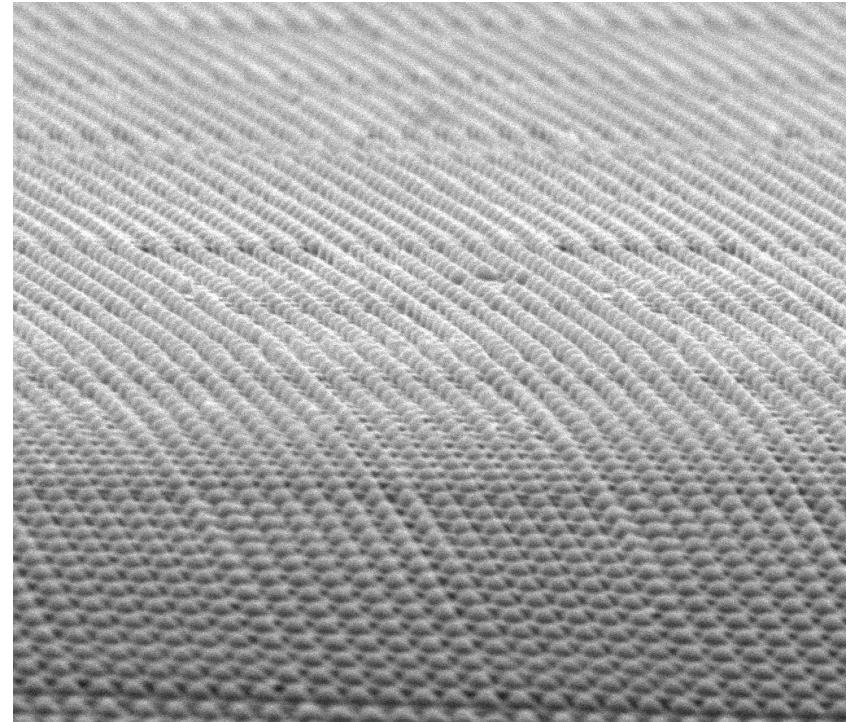
Dr. Stephen Furst (PI), CEO
furst@smartmaterialsolutions.com
Team: Nichole Cates and Lauren Micklow

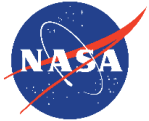
University of Texas, Austin:

Dr. Chih-Hao Chang (co-PI), Asst. Prof. of Mech. Engr.
chichang@utexas.edu
Team: Samuel Lee, Suarav Mohanty, and Kun-Chieh Chien



- Project goals
- Summary of achievements
 - Surface textures
 - Fabricated surfaces
 - Dust mitigation performance
- Proposed future work





Passive Nano- and Micro-Textured Dust-Mitigation Surfaces in Space-Grade Materials Made with a Highly Scalable Fabrication Process (5/19/21 – 11/19/21)

Smart Material Solutions



Dr. Stephen Furst (PI)
Founder and CEO
PhD in Mechanical Engineering
specialized in precision engineering



Dr. Nichole Cates
Senior Scientist
PhD in Materials Science specialized
in electronic materials



Lauren Micklow
Mechanical Engineer
BS in Mechanical Engineering

UT Austin



Dr. Chih-Hao Chang (co-PI)
Associate Professor Mechanical Engineering
Nanostructures and Nanomanufacturing Lab

Students

Samuel Lee, Suarav Mohanty, and Kun-Chieh Chien

NASA

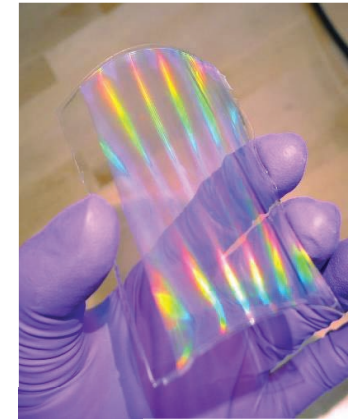
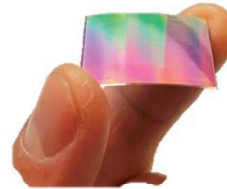
Glen King, Chris Wohl, and Lopamudra Das
NASA Langley Research Center

Objective: Use our scalable process to imprint “space grade materials” with passive structured surfaces that reduce dust adhesion.

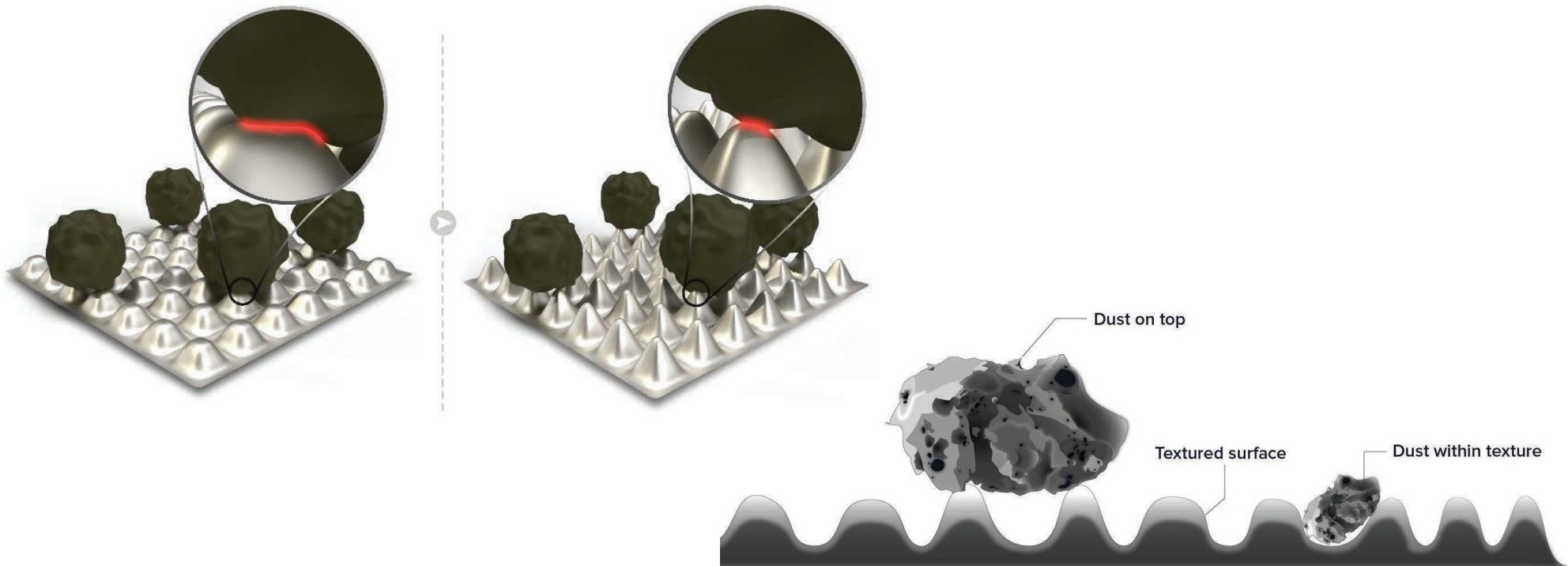


Tasks:

1. Texture Optimization
2. Flexible Mold Fabrication
3. Replication and Metrology
4. Chemical Treatment and Testing

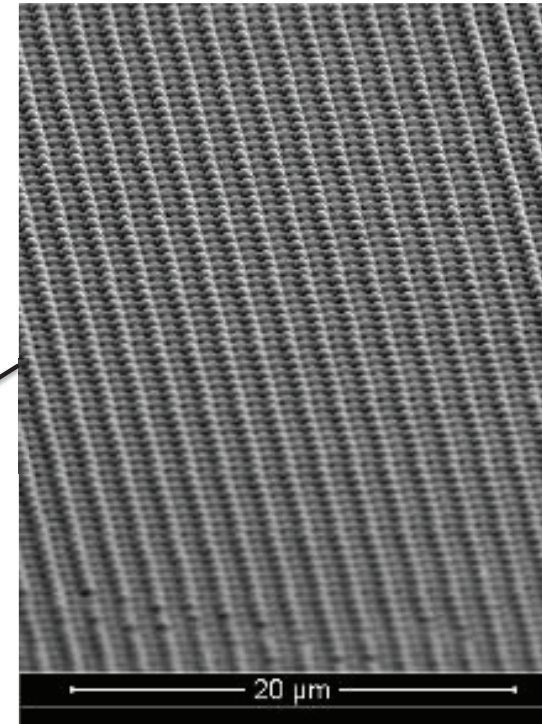
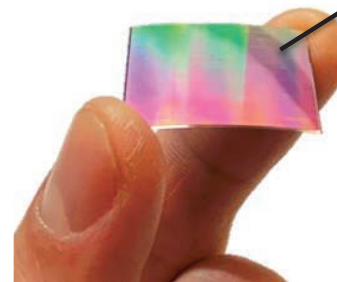
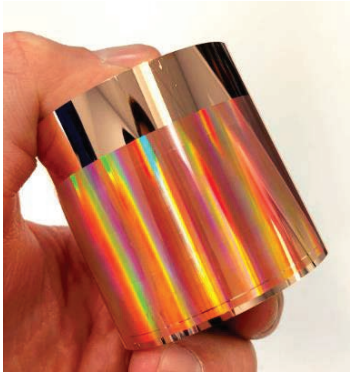


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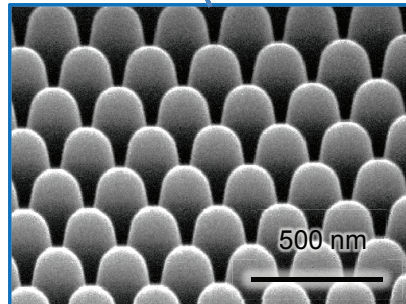
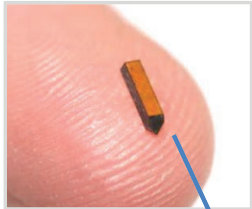


Nanoimprint lithography molds

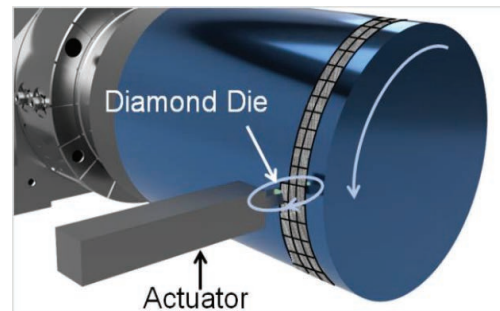
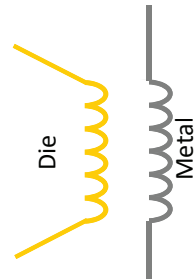
- Seamless, roll-to-roll
- Batch, thermal embossing



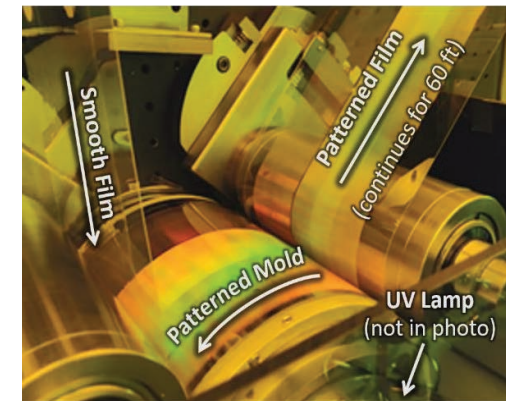
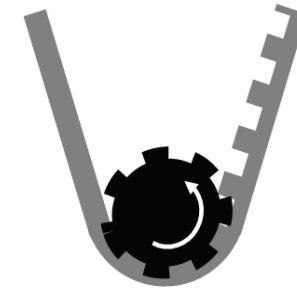
1. Diamond die



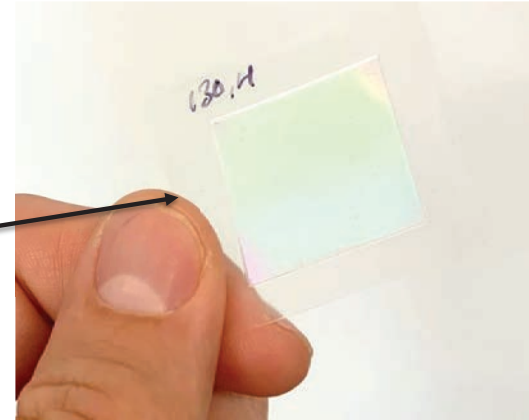
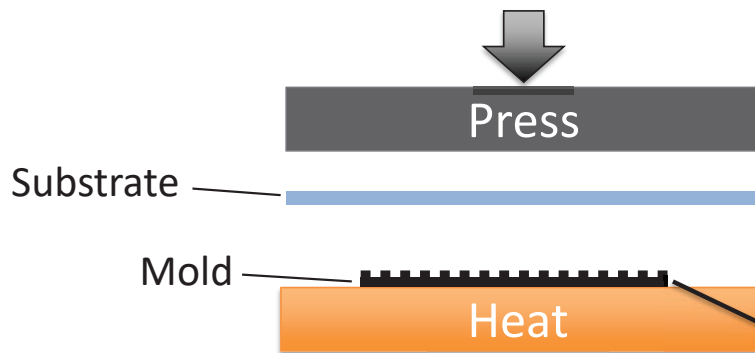
2. High speed indenting



3. Imprinting

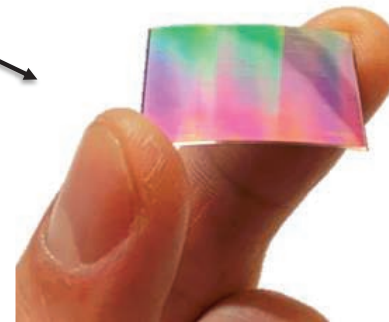


Nanocoining

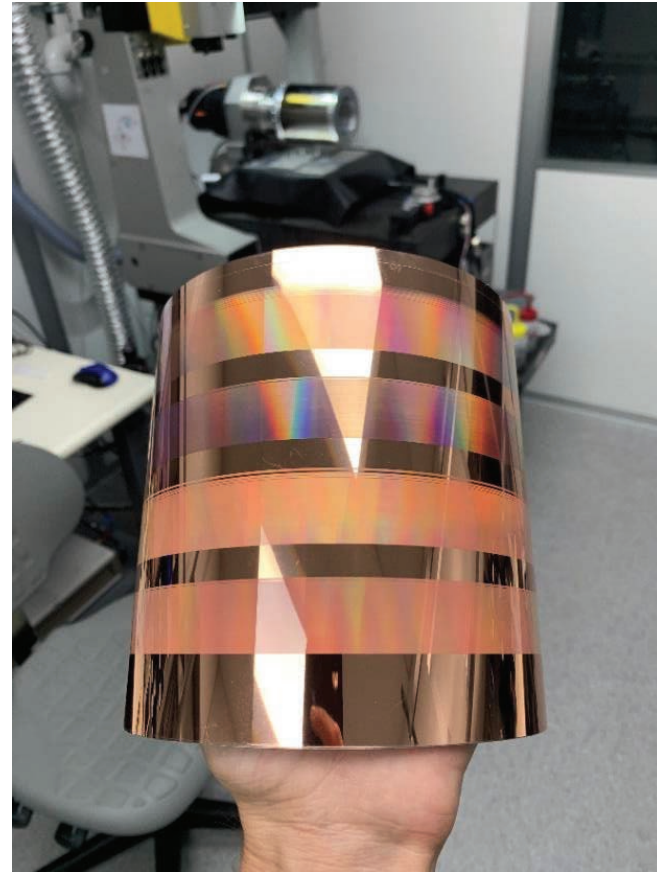
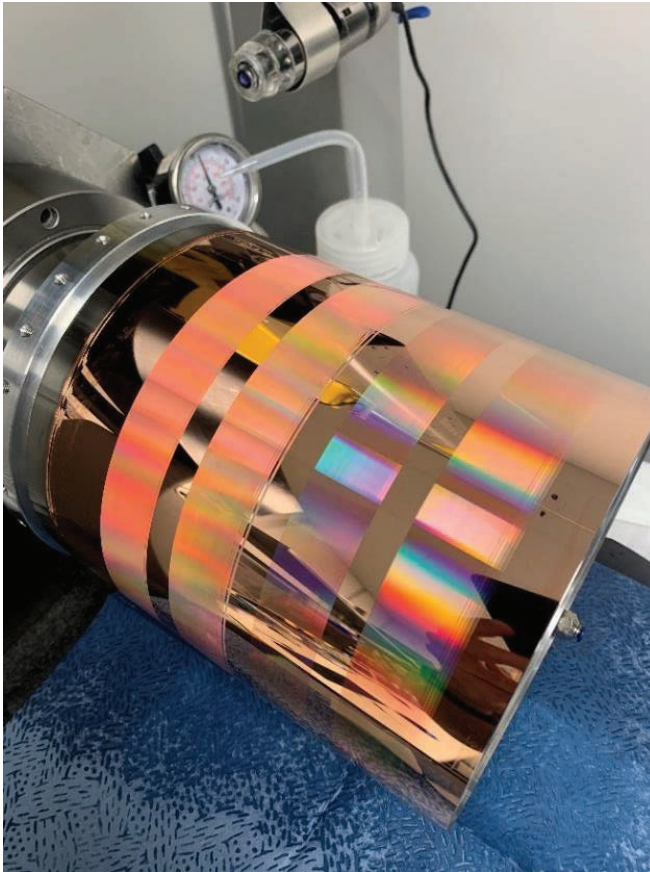


Materials of Interest

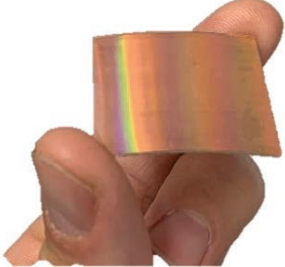
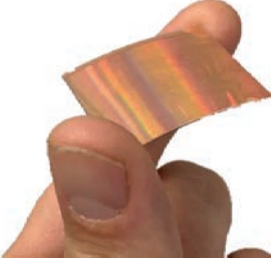
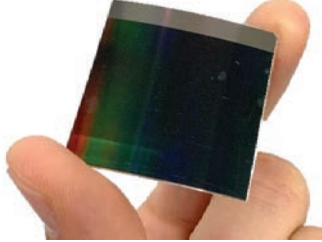
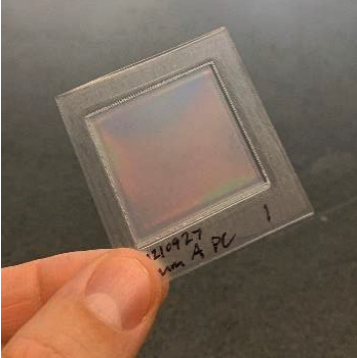
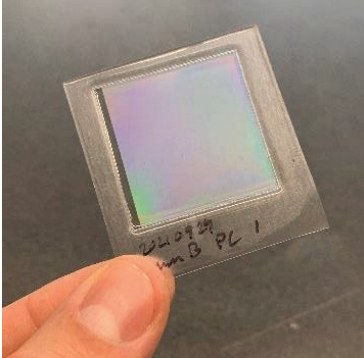
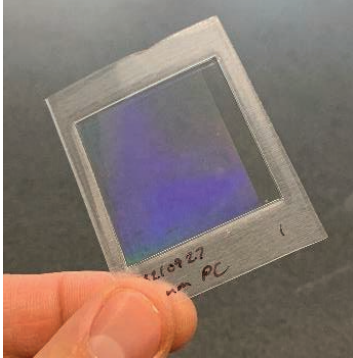
- Polycarbonate (Markrofol N)
- ETFE (Tefzel 280)
- CoC (Zeonor)
- PET (Mylar)
- Polyimide (Kapton)
- PTFE (Teflon)



Key challenge – complete imprints into space grade polymers

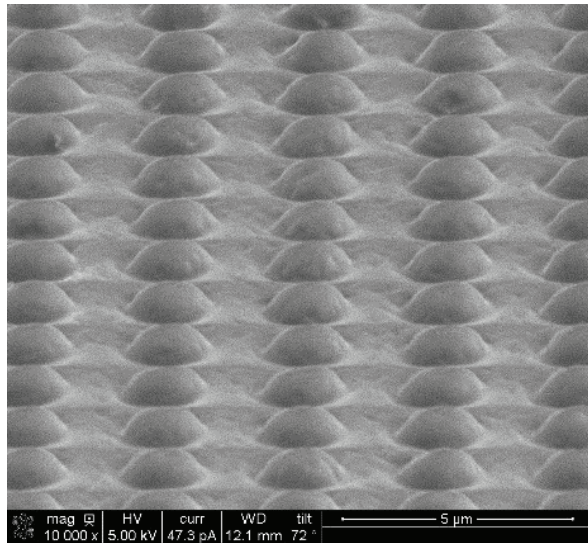


Molds and Replicas

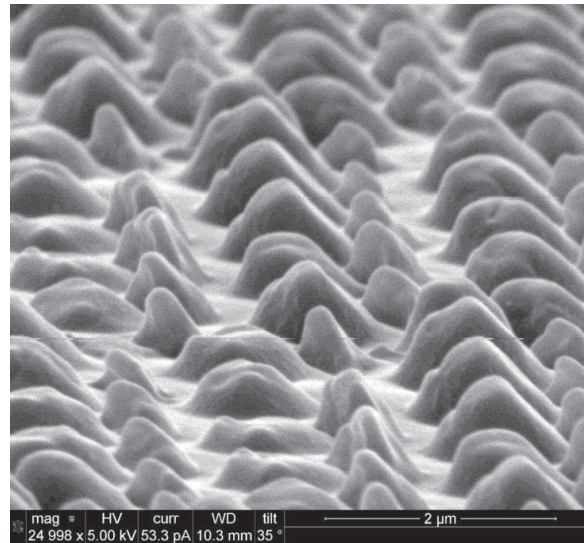
	Sample 1	Sample 2	Sample 3
Mold			
PC Replica			

Current capabilities: 250 nm to 5 μm pitch and 0.5 height:pitch

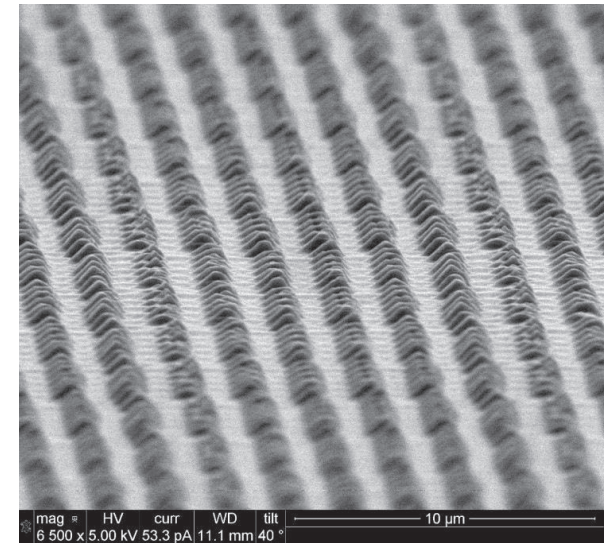
Rounded



Irregular



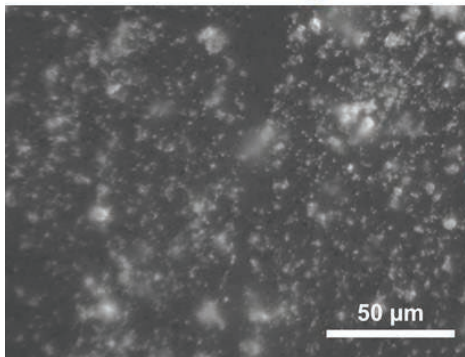
Sharper



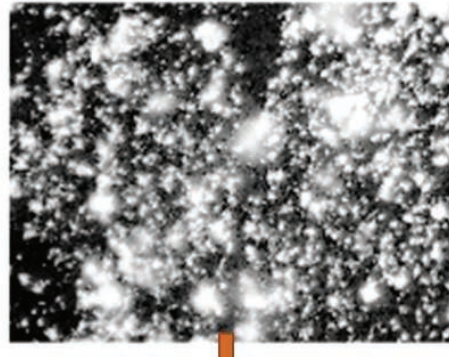
- Lunar Dust Simulant: Exolith Labs LMS-1
- Polycarbonate substrates w/ and w/out silane coating
- Procedure:
 1. Heap dust on surface
 2. Tilt to 90 degrees
 3. Take micrograph
 4. Spin on spin coater, 3G
 5. Take another micrograph
 6. Image analysis

Visible Microscope

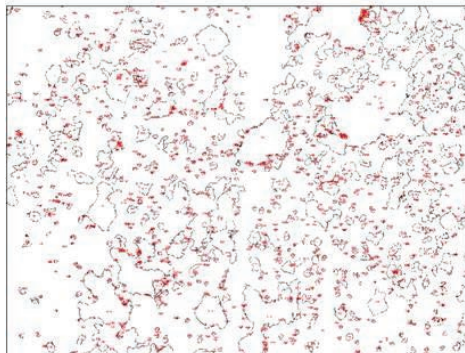
Raw image



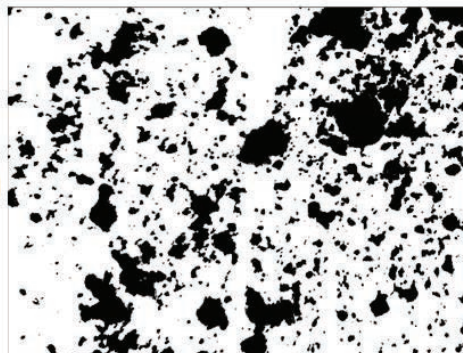
Enhanced contrast



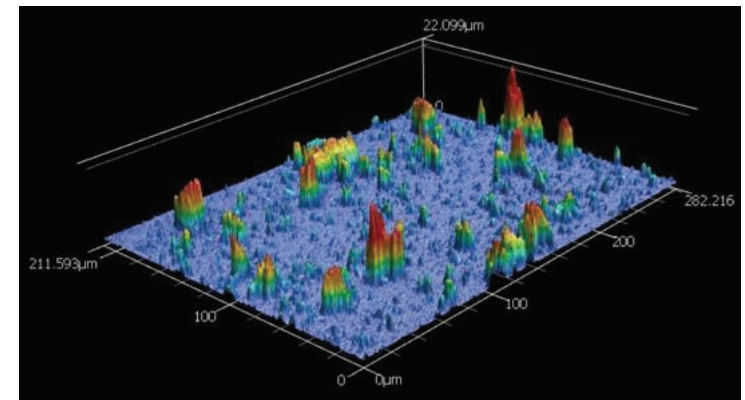
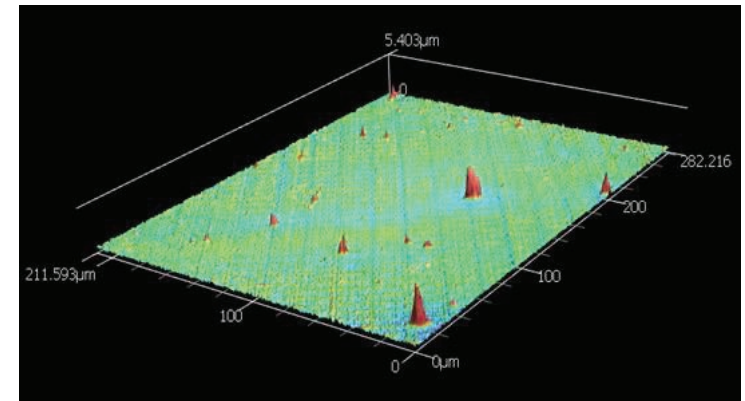
Particle counting



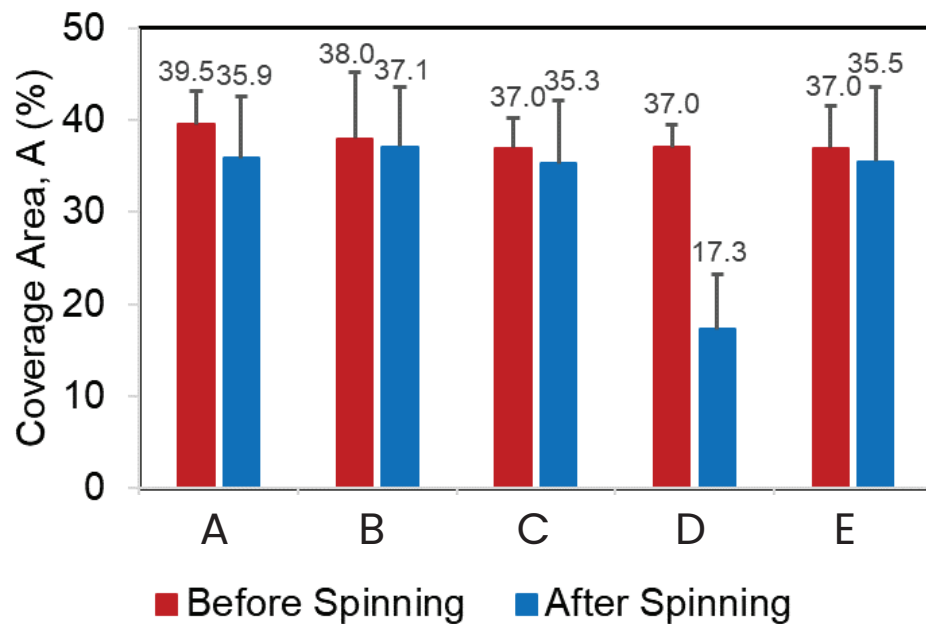
Particle identification



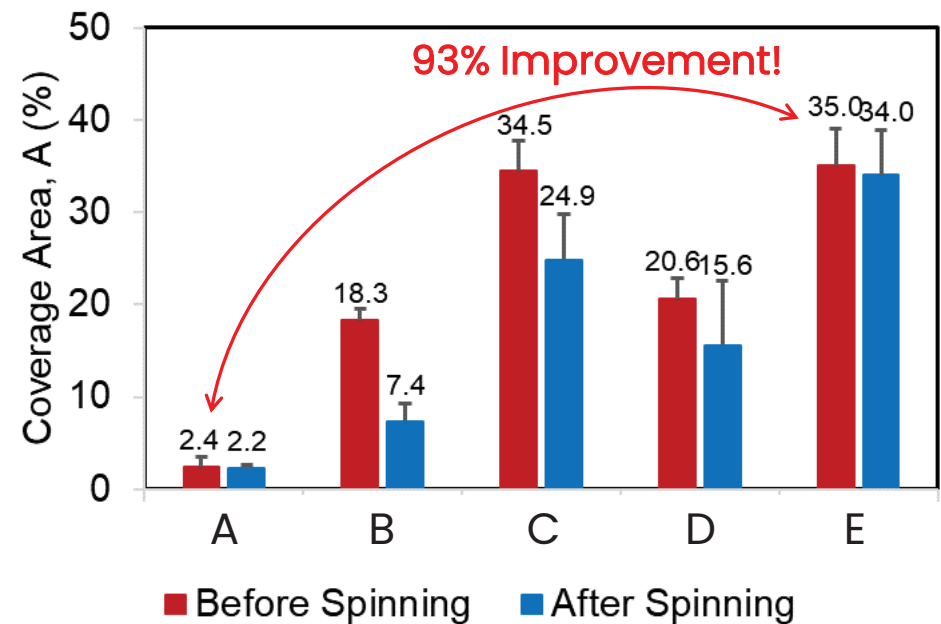
Laser Confocal



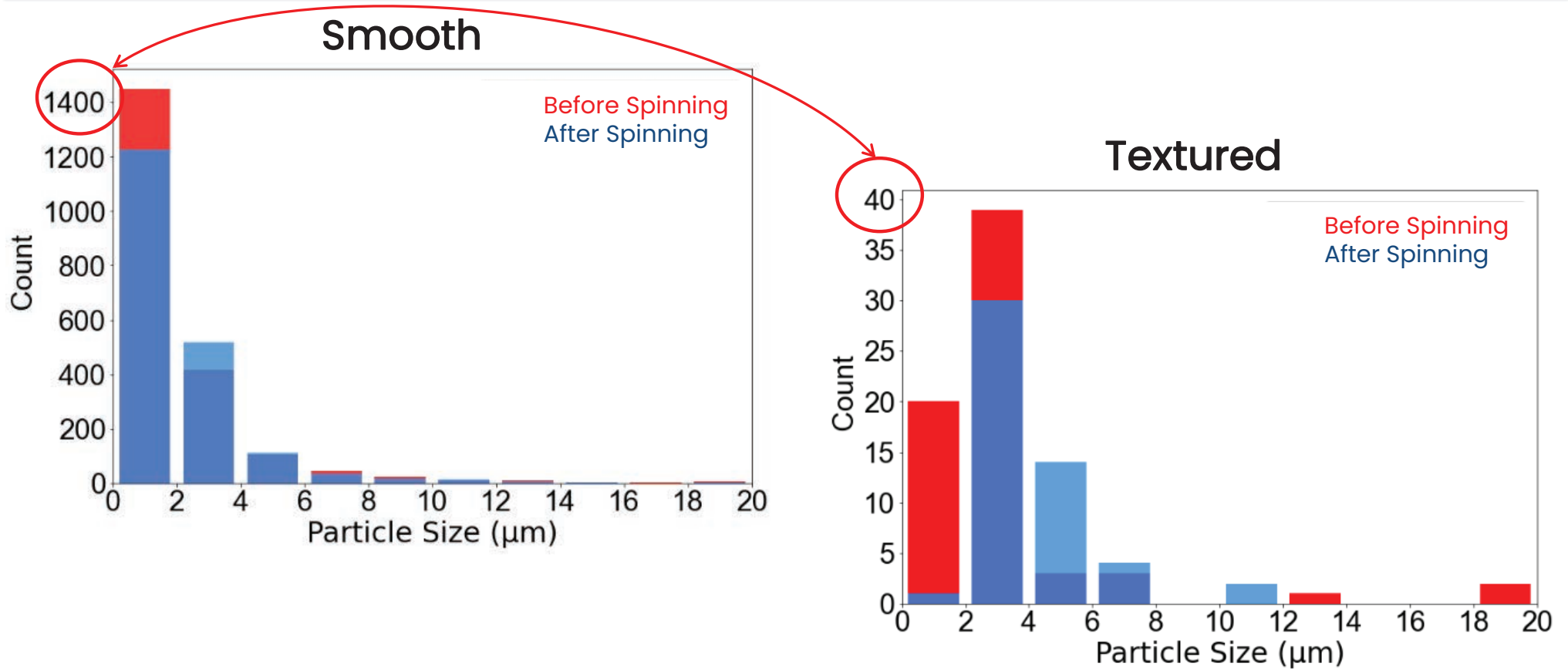
No Silane Treatment

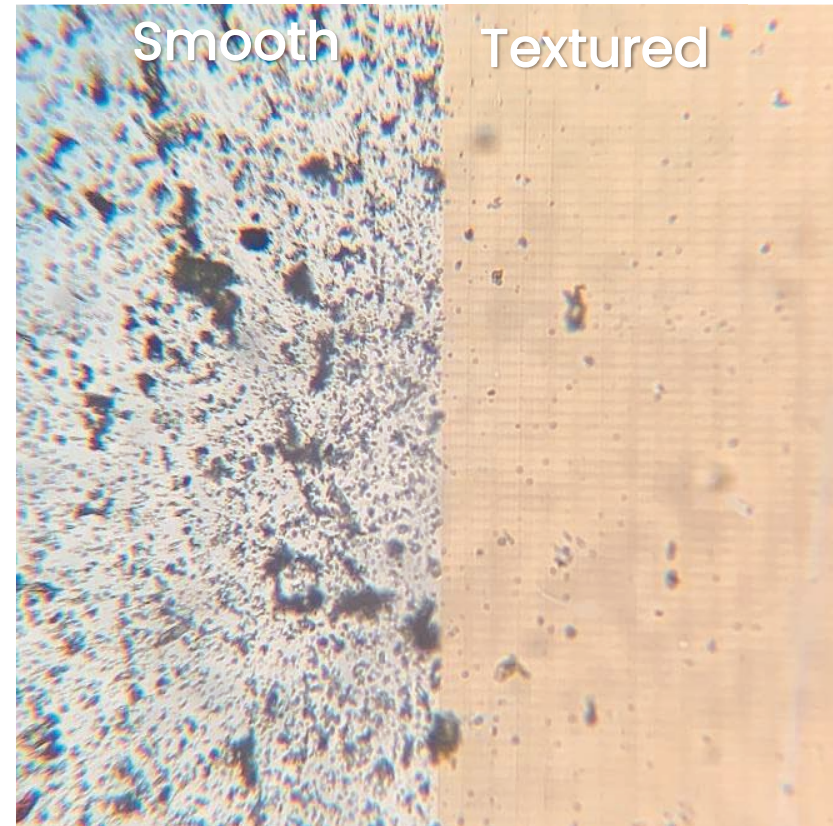


With Silane Treatment

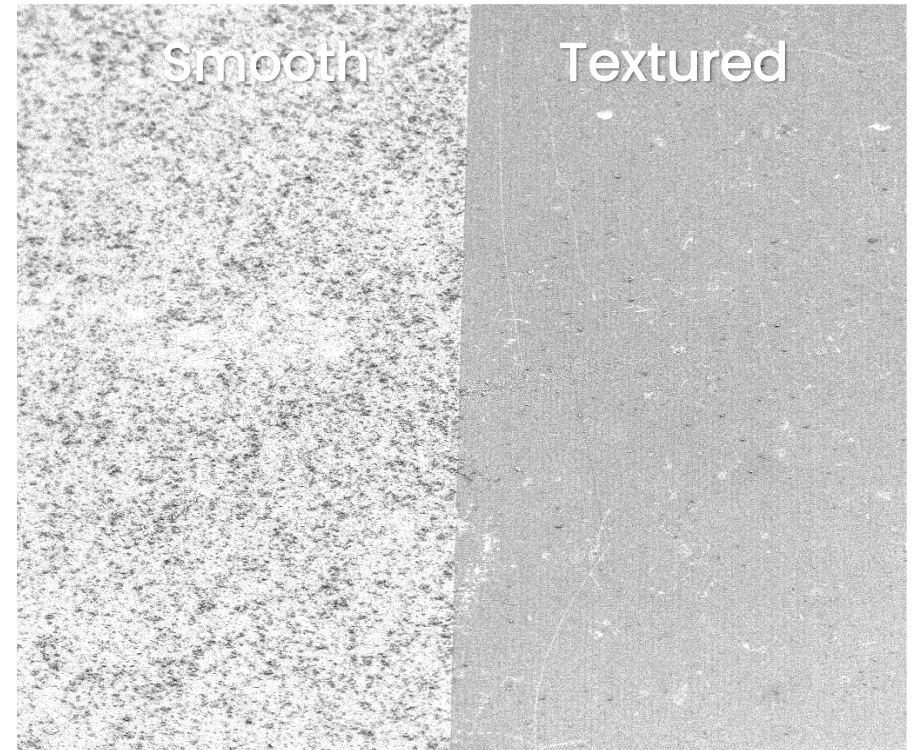
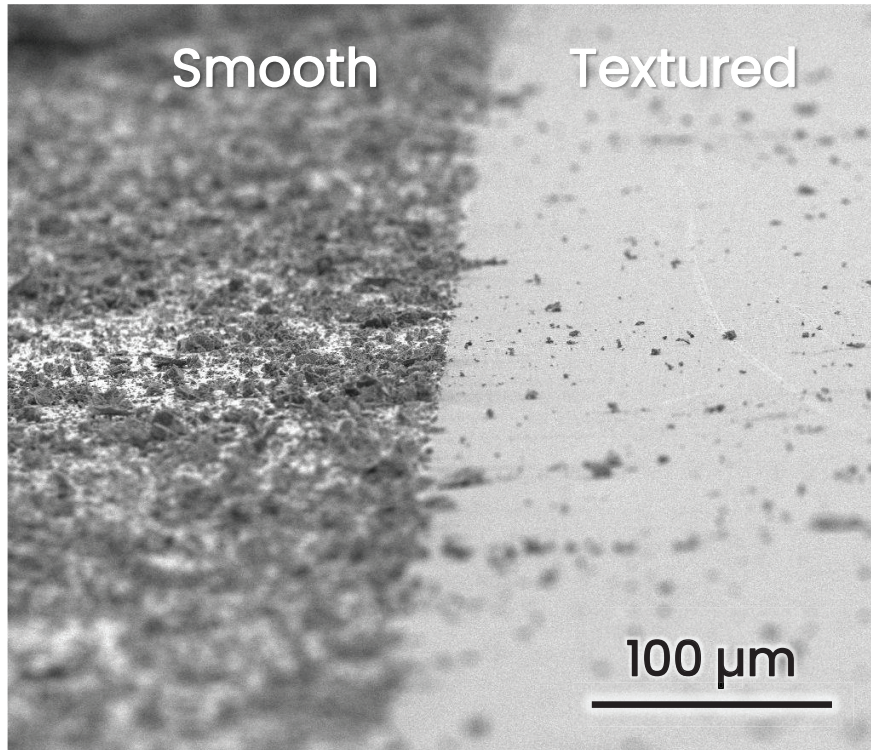


Particle Distribution

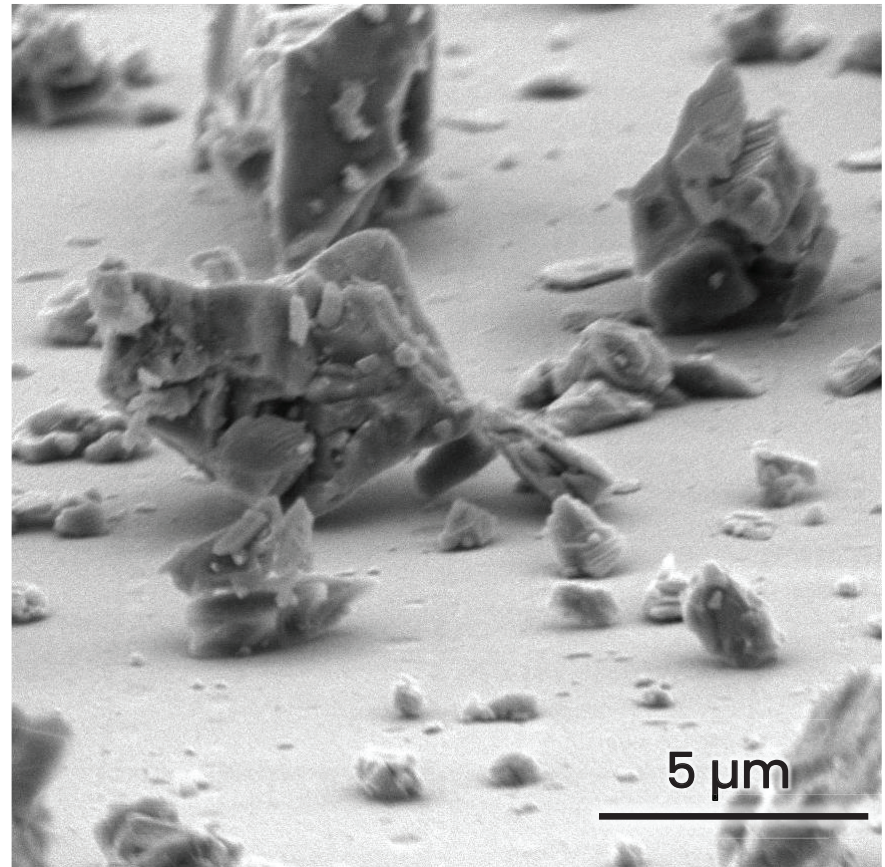
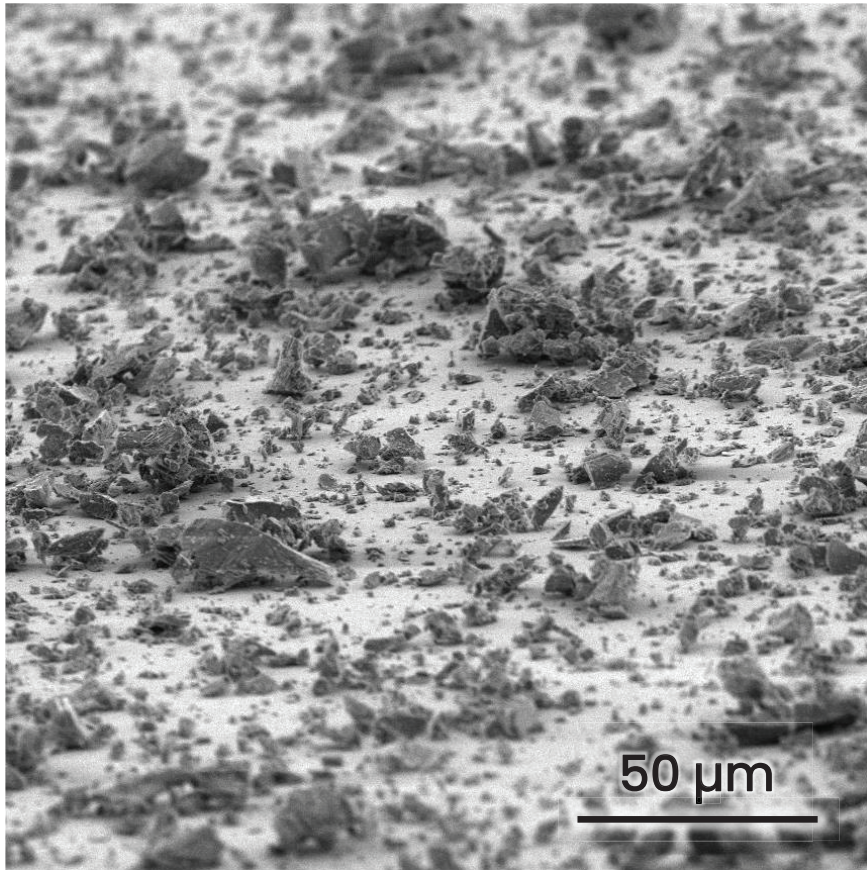




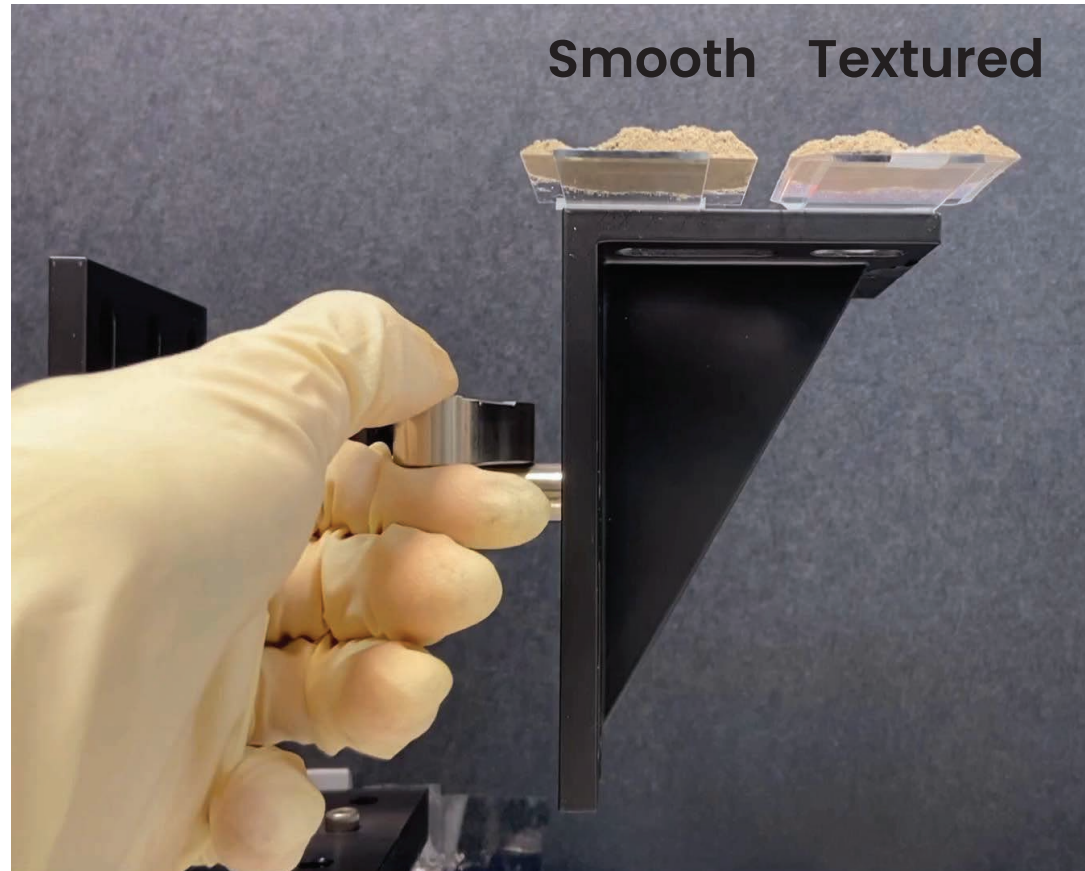
Seam: Electron Microscopy



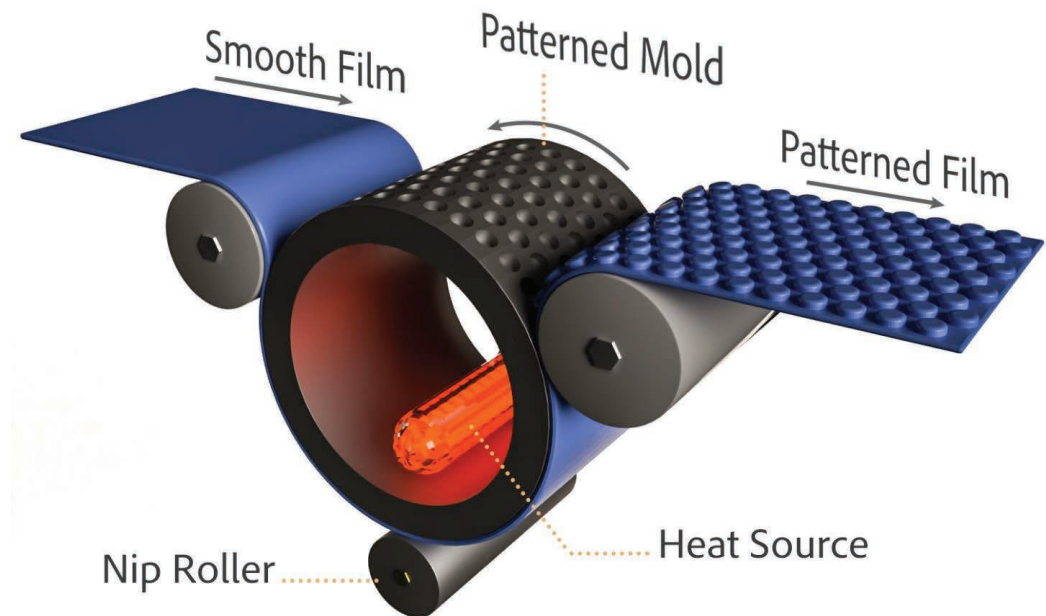
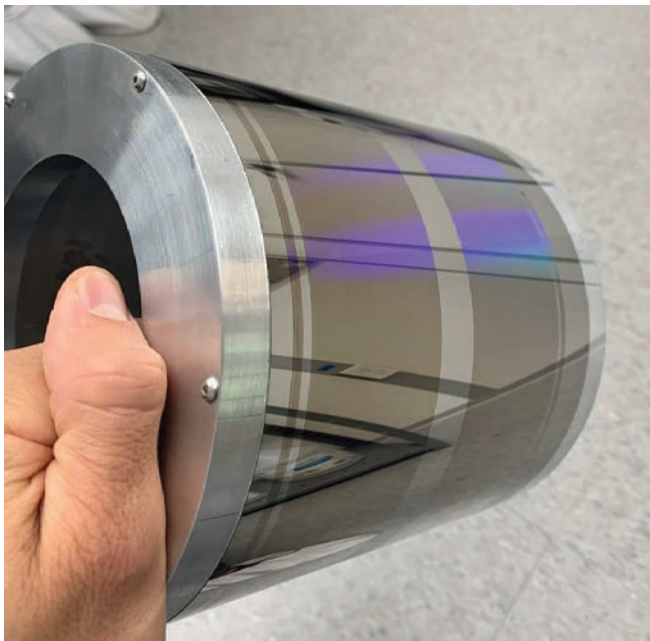
Dust on Smooth Polycarbonate



Dust-Mitigating Surfaces



- 6.5" drum with 300 nm features (SMS)
- Thermal NIL into PC, 1.5 m/min (MiCon)



<https://youtu.be/2WzndwDG9SY>

1: Adhesion Physics

- What **geometric characteristics** matter?
- Will low **surface energy** materials demonstrate the dust-mitigating effect without a silane coating?
- What happens if we increase the **excitation force** ?

2: Scale and Form Factors

- Roll-to-roll imprinting
- Pattern transfer to PTFE, polyimide, PET, FEP via imprinting and etching
- Application to solar cells, radiator strips, food bags, and camera optics

3: Relevant Testing

- Vacuum, temperature, static charge, and humidity
- Repeated dust loading cycles
- Abrasion and thermal stress testing



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